74LVC132A-Q100

Quad 2-input NAND Schmitt trigger

Rev. 2 — 6 July 2020 Product data sheet

1. General description

The 74LVC132A-Q100 provides four 2-input NAND gates with Schmitt trigger inputs. It can transform slowly changing input signals into sharply defined, jitter-free output signals.

The inputs switch at different points for positive and negative-going signals. The difference between the positive voltage V_{T+} and the negative voltage V_{T-} is defined as the input hysteresis voltage V_H.

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environment.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 1.2 V to 3.6 V
- 5 V tolerant inputs for interfacing with 5 V logic
- CMOS low-power consumption
- Direct interface with TTL levels
- Unlimited input rise and fall times
- Inputs accept voltages up to 5.5 V
- Complies with JEDEC standard JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options
- DHVQFN package with Side-Wettable Flanks enabling Automatic Optical Inspection (AOI) of solder joints

3. Applications

- Wave and pulse shapers for highly noisy environments
- Astable multivibrator
- Monostable multivibrator.

4. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC132AD-Q100	-40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74LVC132APW-Q100	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
74LVC132ABQ-Q100	-40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm	SOT762-1

5. Functional diagram

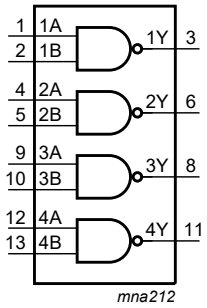


Fig. 1. Logic symbol

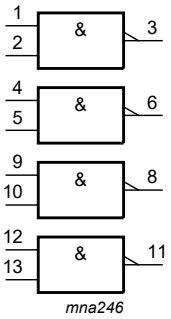


Fig. 2. IEC logic symbol

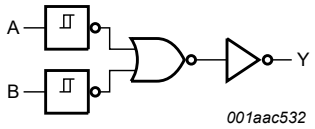


Fig. 3. Logic diagram (one gate)

6. Pinning information

6.1. Pinning

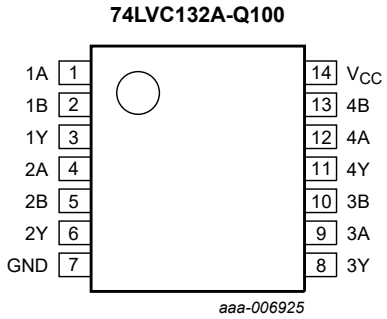
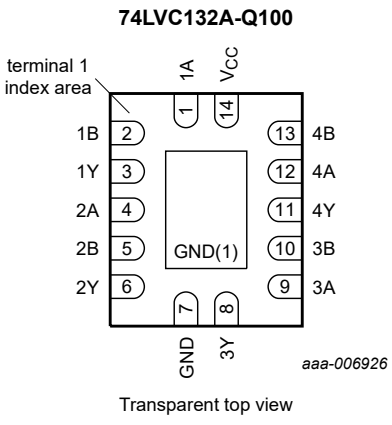


Fig. 4. Pin configuration SOT108-1 (SO14) and SOT402-1 (TSSOP14)



Transparent top view

(1) This is not a ground pin. There is no electrical or mechanical requirement to solder the pad. In case soldered, the solder land should remain floating or connected to GND.

Fig. 5. Pin configuration SOT762-1 (DHVQFN14)

6.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1A, 2A, 3A, 4A	1, 4, 9, 12	data input
1B, 2B, 3B, 4B	2, 5, 10, 13	data input
1Y, 2Y, 3Y, 4Y	3, 6, 8, 11	data output
GND	7	ground (0 V)
V_{CC}	14	supply voltage

7. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level.

Input		Output
nA	**nB**	**nY**
L	L	H
L	H	H
H	L	H
H	H	L

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+6.5	V
V_I	input voltage	[1]	-0.5	+6.5	V
V_O	output voltage	[2]	-0.5	V_{CC} + 0.5	V
I_{IK}	input clamping current	V_I < 0 V	-50	-	mA
I_{OK}	output clamping current	V_O > V_{CC} or V_O < 0 V	-	±50	mA
I_O	output current	V_O = 0 V to V_{CC}	-	±50	mA
I_{CC}	supply current		-	100	mA
I_{GND}	ground current		-100	-	mA
T_{stg}	storage temperature		-65	+150	°C
P_{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C [3]	-	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.
[2] The output voltage ratings may be exceeded if the output current ratings are observed.
[3] For SOT108-1 (SO14) package: P_{tot} derates linearly with 10.1 mW/K above 100 °C.
For SOT402-1 (TSSOP14) package: P_{tot} derates linearly with 7.3 mW/K above 81 °C.
For SOT762-1 (DHVQFN14) package: P_{tot} derates linearly with 9.6 mW/K above 98 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
V_I	input voltage		0	-	5.5	V
V_O	output voltage		0	-	V_{CC}	V
T_{amb}	ambient temperature		-40	-	+125	°C

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ [1]	Max	Unit
T_{amb} = -40 °C to +85 °C						
V_{OH}	HIGH-level output voltage	$V_I = V_{T+}$ or V_{T-}				
		I_O = -100 µA; V_{CC} = 1.65 V to 3.6 V	V_{CC} - 0.2	-	-	V
		I_O = -4 mA; V_{CC} = 1.65 V	V_{CC} - 0.45	-	-	V
		I_O = -8 mA; V_{CC} = 2.3 V	V_{CC} - 0.5	-	-	V
		I_O = -12 mA; V_{CC} = 2.7 V	V_{CC} - 0.5	-	-	V
		I_O = -18 mA; V_{CC} = 3.0 V	V_{CC} - 0.6	-	-	V
		I_O = -24 mA; V_{CC} = 3.0 V	V_{CC} - 0.8	-	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{T+}$ or V_{T-}				
		I_O = 100 µA; V_{CC} = 1.65 V to 3.6 V	-	-	0.2	V
		I_O = 4 mA; V_{CC} = 1.65 V	-	-	0.45	V
		I_O = 8 mA; V_{CC} = 2.3 V	-	-	0.6	V
		I_O = 12 mA; V_{CC} = 2.7 V	-	-	0.4	V
		I_O = 24 mA; V_{CC} = 3.0 V	-	-	0.55	V
I_I	input leakage current	V_{CC} = 3.6 V; V_I = 5.5 V or GND	-	±0.1	±5	µA
I_{CC}	supply current	V_{CC} = 3.6 V; V_I = V_{CC} or GND; I_O = 0 A	-	0.1	10	µA
ΔI_{CC}	additional supply current	per input pin; V_{CC} = 2.7 V to 3.6 V; V_I = V_{CC} - 0.6 V; I_O = 0 A	-	5	500	µA
C_I	input capacitance	V_{CC} = 0 V to 3.6 V; V_I = GND to V_{CC}	-	4.0	-	pF

Symbol	Parameter	Conditions	Min	Typ [1]	Max	Unit
T_{amb} = -40 °C to +125 °C						
V_{OH}	HIGH-level output voltage	V_I = V_{T+} or V_{T-}				
		I_O = -100 µA; V_{CC} = 1.65 V to 3.6 V	V_{CC} - 0.3	-	-	V
		I_O = -4 mA; V_{CC} = 1.65 V	V_{CC} - 0.6	-	-	V
		I_O = -8 mA; V_{CC} = 2.3 V	V_{CC} - 0.65	-	-	V
		I_O = -12 mA; V_{CC} = 2.7 V	V_{CC} - 0.65	-	-	V
		I_O = -18 mA; V_{CC} = 3.0 V	V_{CC} - 0.75	-	-	V
		I_O = -24 mA; V_{CC} = 3.0 V	V_{CC} - 1	-	-	V
V_{OL}	LOW-level output voltage	V_I = V_{T+} or V_{T-}				
		I_O = 100 µA; V_{CC} = 1.65 V to 3.6 V	-	-	0.3	V
		I_O = 4 mA; V_{CC} = 1.65 V	-	-	0.65	V
		I_O = 8 mA; V_{CC} = 2.3 V	-	-	0.8	V
		I_O = 12 mA; V_{CC} = 2.7 V	-	-	0.6	V
		I_O = 24 mA; V_{CC} = 3.0 V	-	-	0.8	V
I_I	input leakage current	V_{CC} = 3.6 V; V_I = 5.5 V or GND	-	-	±20	µA
I_{CC}	supply current	V_{CC} = 3.6 V; V_I = V_{CC} or GND; I_O = 0 A	-	-	40	µA
ΔI_{CC}	additional supply current	per input pin; V_{CC} = 2.7 V to 3.6 V; V_I = V_{CC} - 0.6 V; I_O = 0 A	-	-	5	mA

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

11. Dynamic characteristics

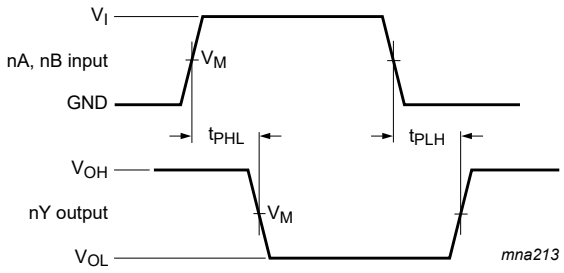
Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 7.

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ [1]	Max	Min	Max	
t_{pd}	propagation delay	nA, nB to nY; see Fig. 6 [2]						
		V_{CC} = 1.2 V	-	18.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V	2.0	7.2	12.8	2.0	16.0	ns
		V_{CC} = 2.3 V to 2.7 V	1.5	4.0	7.6	1.5	9.6	ns
		V_{CC} = 2.7 V	1.5	3.8	7.6	1.5	9.6	ns
		V_{CC} = 3.0 V to 3.6 V	1.5	3.4	6.4	1.5	8.0	ns
$t_{sk(o)}$	output skew time	[3]	-	-	1.0	-	1.5	ns
C_{PD}	power dissipation capacitance	per buffer; V_I = GND to V_{CC} [4]						
		V_{CC} = 1.65 V to 1.95 V	-	10.5	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V	-	10.8	-	-	-	pF
		V_{CC} = 3.0 V to 3.6 V	-	11.4	-	-	-	pF

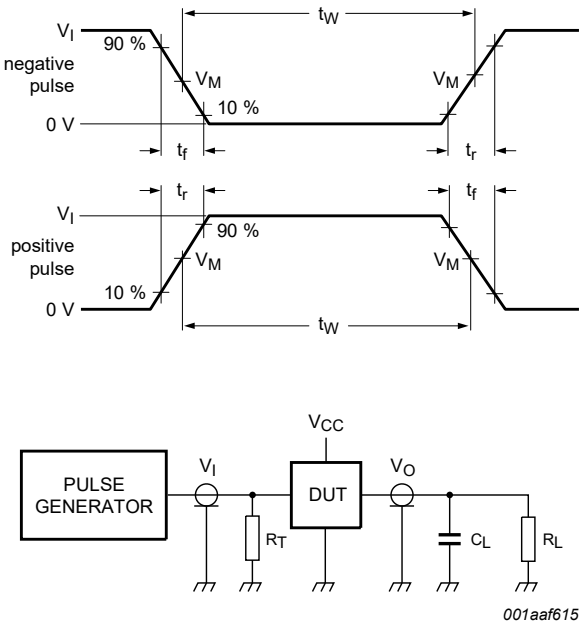
[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.
[2] t_{pd} is the same as t_{PLH} and t_{PHL}.
[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
[4] C_{PD} is used to determine the dynamic power dissipation (P_D in µW). $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:
f_i = input frequency in MHz; f_o = output frequency in MHz;
N = number of inputs switching;
C_L = output load capacitance in pF;
V_{CC} = supply voltage in V;
$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

11.1. Waveforms and test circuit



V_M = 1.5 V at V_{CC} ≥ 2.7 V.
V_M = 0.5 × V_{CC} at V_{CC} < 2.7 V.
V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 6. The input (nA, nB) to output (nY) propagation delays



Test data is given in Table 8. Definitions for test circuit:
R_L = Load resistance
C_L = Load capacitance including jig and probe capacitance
R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

Fig. 7. Test circuit for measuring switching times

Table 8. Test data

Supply voltage	Input		Load	
	V_I	t_r, t_f	C_L	R_L
1.2 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ
1.65 V to 1.95 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ
2.3 V to 2.7 V	V_{CC}	≤ 2 ns	30 pF	500 Ω
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω

12. Transfer characteristics

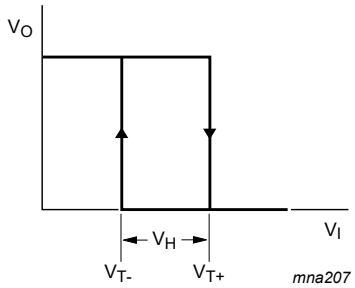
Table 9. Transfer characteristics

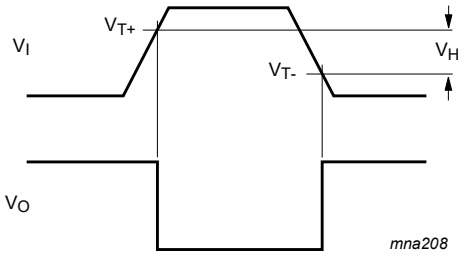
Voltages are referenced to GND (ground = 0 V); see Fig. 8.

Symbol	Parameter	Conditions	-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Max	Min	Max	
V_{T+}	positive-going threshold voltage	V_{CC} = 1.2 V	0.2	1.0	0.2	1.0	V
		V_{CC} = 1.65 V	0.4	1.3	0.4	1.3	V
		V_{CC} = 1.95 V	0.6	1.5	0.6	1.5	V
		V_{CC} = 2.3 V	0.8	1.7	0.8	1.7	V
		V_{CC} = 2.5 V	0.9	1.7	0.9	1.7	V
		V_{CC} = 2.7 V	1.1	2	1.1	2	V
		V_{CC} = 3 V	1.2	2	1.2	2	V
		V_{CC} = 3.6 V	1.2	2	1.2	2	V
V_{T-}	negative-going threshold voltage	V_{CC} = 1.2 V	0.12	0.75	0.12	0.75	V
		V_{CC} = 1.65 V	0.15	0.85	0.15	0.85	V
		V_{CC} = 1.95 V	0.25	0.95	0.25	0.95	V
		V_{CC} = 2.3 V	0.4	1.1	0.4	1.1	V
		V_{CC} = 2.5 V	0.4	1.2	0.4	1.2	V
		V_{CC} = 2.7 V	0.8	1.4	0.8	1.4	V
		V_{CC} = 3 V	0.8	1.5	0.8	1.5	V
		V_{CC} = 3.6 V	0.8	1.5	0.8	1.5	V
V_H	hysteresis voltage (V_{T+} - V_{T-})	V_{CC} = 1.2 V	0.1	1.0	0.1	1.0	V
		V_{CC} = 1.65 V	0.2	1.15	0.2	1.15	V
		V_{CC} = 1.95 V	0.2	1.25	0.2	1.25	V
		V_{CC} = 2.3 V	0.3	1.3	0.3	1.3	V
		V_{CC} = 2.5 V	0.3	1.3	0.3	1.3	V
		V_{CC} = 2.7 V	0.3	1.1	0.3	1.1	V
		V_{CC} = 3 V	0.3	1.2	0.3	1.2	V
		V_{CC} = 3.6 V [1]	0.3	1.2	0.3	1.2	V

[1] Typical transfer characteristic is displayed in Fig. 9.

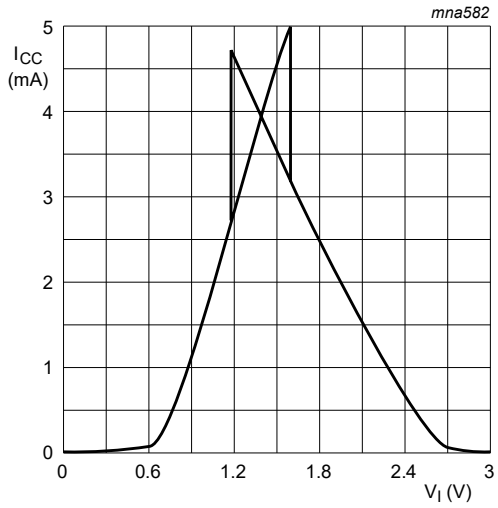
12.1. Waveforms transfer characteristics





V_{T-} at 20 % and V_{T+} at 70 %

Fig. 8. Definition of V_{T+}, V_{T-} and V_H

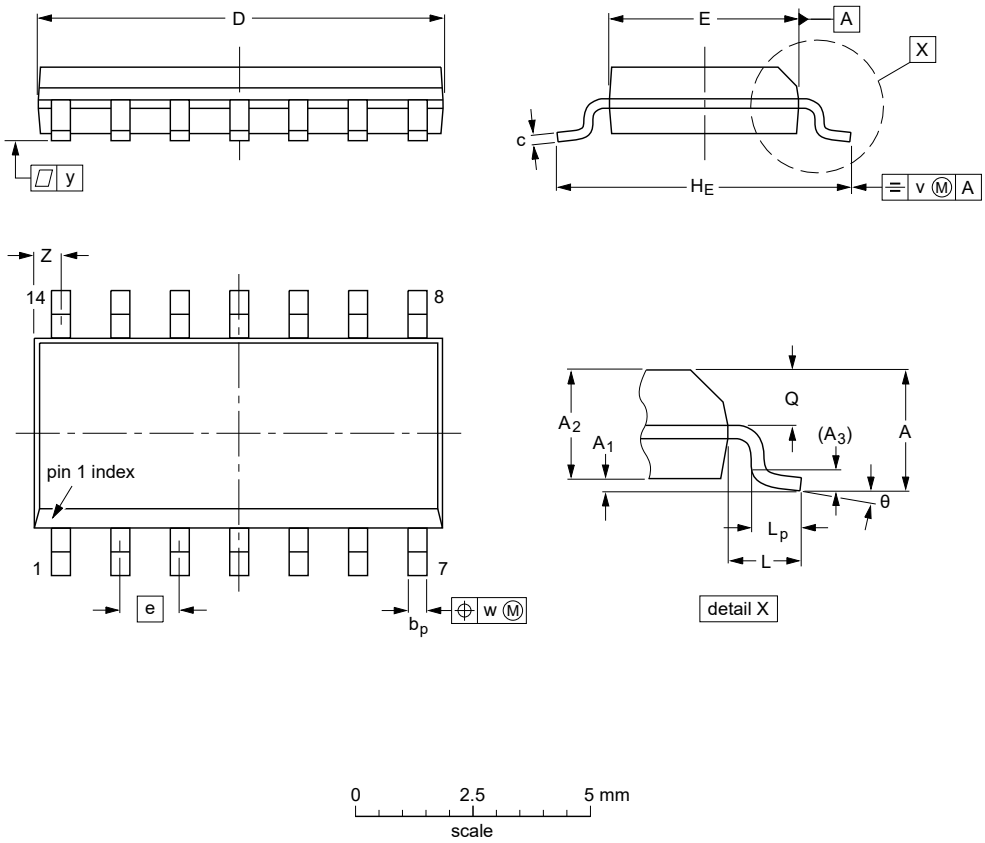


V_{CC} = 3.3 V.

Fig. 9. Typical transfer characteristic

13. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm **SOT108-1**



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8^{o} 0^{o}
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.35 0.34	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	

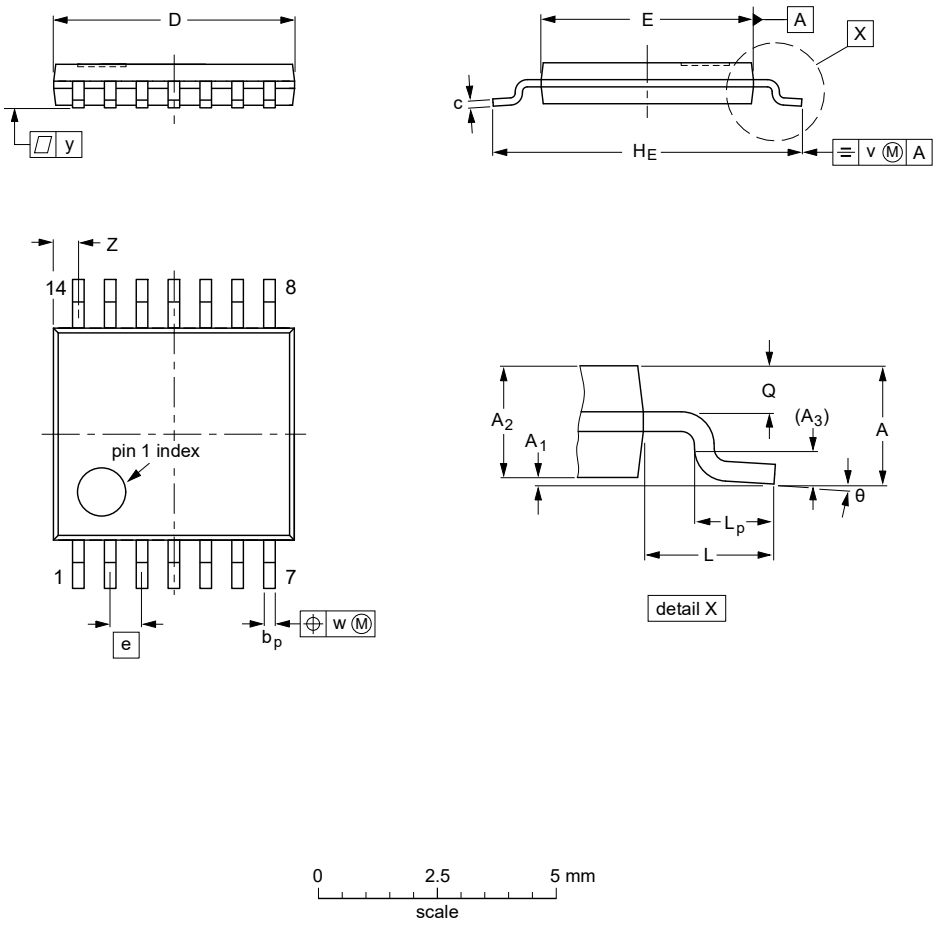
Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT108-1	076E06	MS-012				~~99-12-27~~ 03-02-19

Fig. 10. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm **SOT402-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	D (1)	E (2)	e	H_E	L	L_p	Q	v	w	y	Z (1)	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

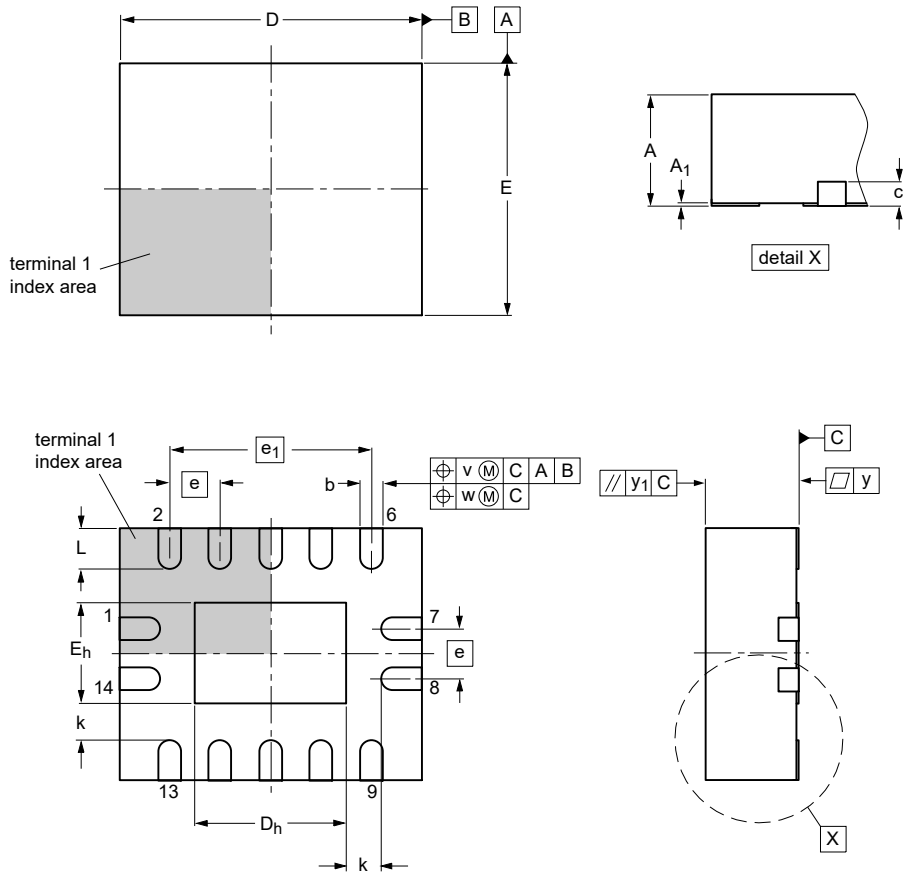
Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT402-1		MO-153				~~99-12-27~~ 03-02-18

Fig. 11. Package outline SOT402-1 (TSSOP14)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm **SOT762-1**



Dimensions (mm are the original dimensions)

Unit		$A^{(1)}$	A_1	b	c	$D^{(1)}$	D_h	$E^{(1)}$	E_h	e	e_1	k	L	v	w	y	y_1
	max	1	0.05	0.30		3.1	1.65	2.6	1.15				0.5				
mm	nom		0.02	0.25	0.2	3.0	1.50	2.5	1.00	0.5	2		0.4	0.1	0.05	0.05	0.1
	min		0.00	0.18		2.9	1.35	2.4	0.85			0.2	0.3				

Note

1. Plastic or metal protrusions of 0.075 mm maximum per side are not included.

sot762-1_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT762-1		MO-241				~~15-04-10~~ 15-05-05

Fig. 12. Package outline SOT762-1 (DHVQFN14)

14. Abbreviations

Table 10. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MIL	Military
MM	Machine Model
TTL	Transistor-Transistor Logic

15. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC132A_Q100 v.2	20200706	Product data sheet	-	74LVC132A_Q100 v.1
Modifications:	• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate. • Section 2 updated. • Table 4: Derating values for P_{tot} total power dissipation updated. • Fig. 12: Package outline drawing SOT762-1 (DHVQFN14) updated.			
74LVC132A_Q100 v.1	20130404	Product data sheet	-	-

16. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
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